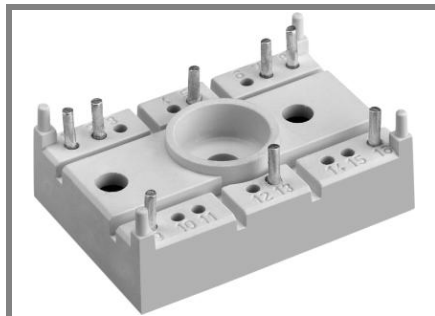


SK 14 GD 063



SEMITOP® 2

IGBT Module

SK 14 GD 063

Target Data

Features

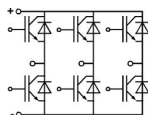
- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N channel, homogeneous Silicon structure (NPT-Non punchthrough IGBT)
- High short circuit capability
- Low tail current with low temperature dependence

Typical Applications

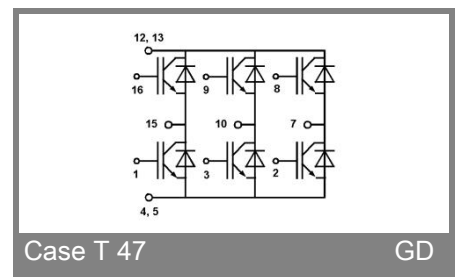
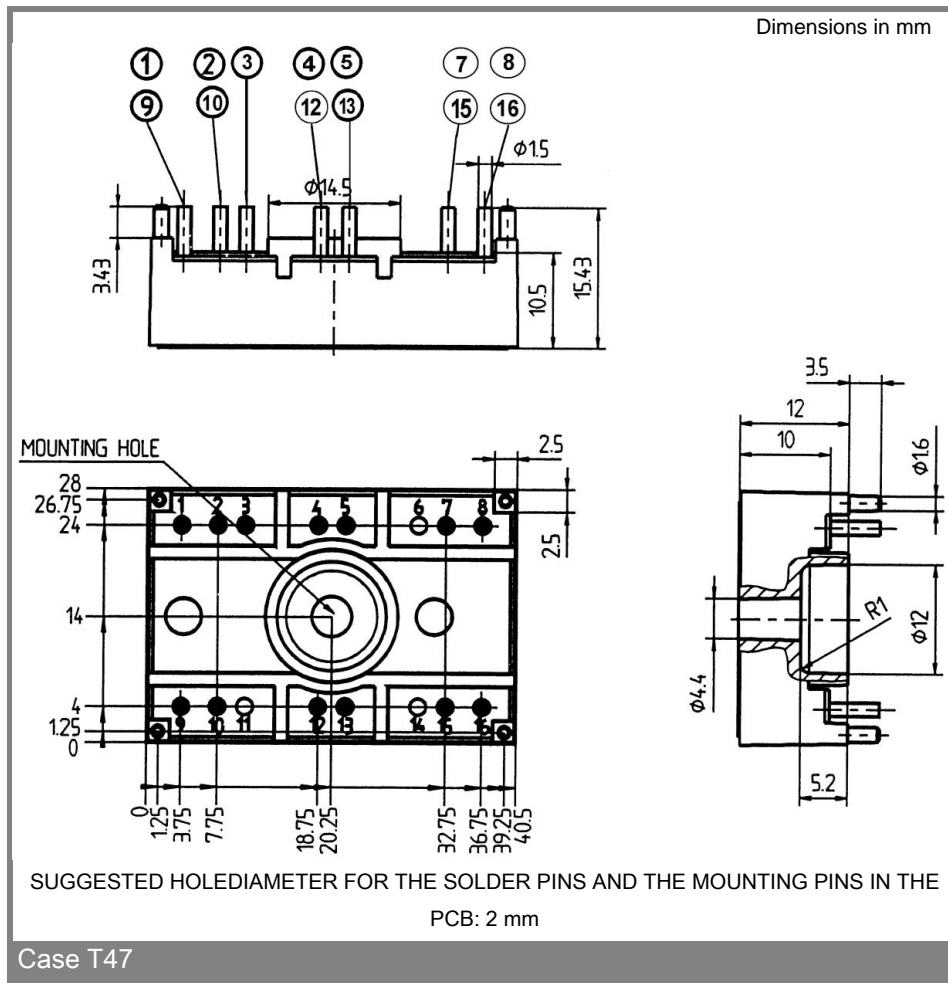
- Switching (not for linear use)
- Inverter
- Switched mode power supplies
- UPS

Absolute Maximum Ratings		$T_s = 25\text{ °C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}		600	V
V_{GES}		± 20	V
I_C	$T_s = 25\text{ (80) °C}$;	18 (13)	A
I_{CM}	$t_p < 1\text{ ms}$; $T_s = 25\text{ (80) °C}$;	36 (26)	A
T_j		- 40 ... + 150	°C
Inverse / Freewheeling CAL diode			
$I_F = -I_C$	$T_s = 25\text{ (80) °C}$;	22 (15)	A
$I_{FM} = -I_{CM}$	$t_p < 1\text{ ms}$; $T_s = 25\text{ (80) °C}$;	44 (30)	A
T_j		- 40 ... + 150	°C
T_{stg}		- 40 ... + 125	°C
T_{sol}	Terminals, 10 s	260	°C
V_{isol}	AC 50 Hz, r.m.s. 1 min. / 1 s	2500 / 3000	V

Characteristics		$T_s = 25\text{ °C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{CE(sat)}$	$I_C = 10\text{ A}$, $T_j = 25\text{ (125) °C}$		2,1 (2,4)	2,5 (2,8)	V
$V_{GE(th)}$	$V_{CE} = V_{GE}$; $I_C = 0,0004\text{ A}$	4,5	5,5	6,5	V
C_{res}	$V_{CE} = 25\text{ V}$; $V_{GE} = 0\text{ V}$; 1 MHz		0,57		nF
$R_{th(j-s)}$	per IGBT			2	K/W
	per module				K/W
$t_{d(on)}$	under following conditions: $V_{CC} = 300\text{ V}$, $V_{GE} = \pm 15\text{ V}$		45		ns
t_r	$I_C = 10\text{ A}$, $T_j = 125\text{ °C}$		45		ns
$t_{d(off)}$	$R_{Gon} = R_{Goff} = 100\text{ }\Omega$		250		ns
t_f			20		ns
$E_{on} + E_{off}$	Inductive load		1		mJ
Inverse / Freewheeling CAL diode					
$V_F = V_{EC}$	$I_F = 10\text{ A}$; $T_j = 25\text{ (125) °C}$		1,45 (1,4)	1,7 (1,7)	V
$V_{(TO)}$	$T_j = (125)\text{ °C}$		(0,85)	(0,9)	V
r_T	$T_j = (125)\text{ °C}$		(55)	(80)	m Ω
$R_{th(j-s)}$				2,3	K/W
I_{RRM}	under following conditions: $I_F = 10\text{ A}$; $V_R = -300\text{ V}$		6,5		A
Q_{rr}	$di_F/dt = -200\text{ A}/\mu\text{s}$		1		μC
E_{off}	$V_{GE} = 0\text{ V}$; $T_j = 125\text{ °C}$		0,1		mJ
Mechanical data					
M1	mounting torque			2	Nm
w			21		g
Case	SEMITOP® 2		T 47		



GD



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.